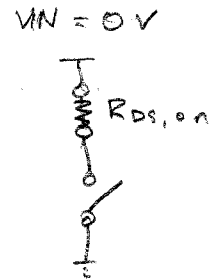
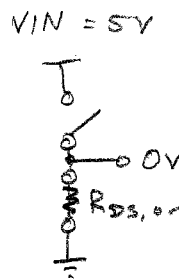
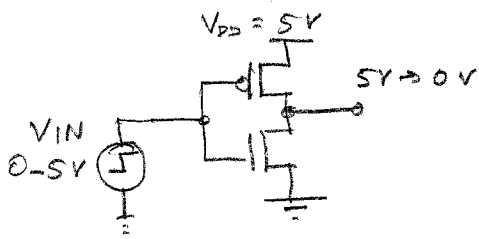


EE105 Lecture: MOSFETs (Part 2), 10/11/2012

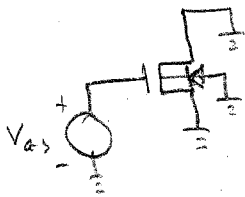
Review from last time

1. MOSFET as switch



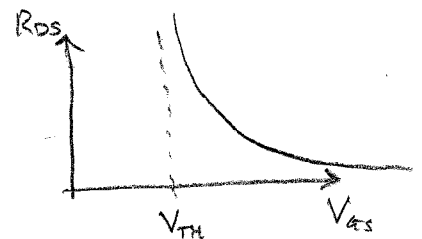
$$R_{DS,on} = \frac{1}{\mu_n C_{ox} \frac{W}{L} (V_{DD} - V_{TH})}$$

2. MOSFET as controlled resistor

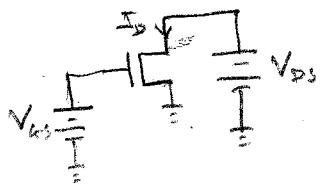


$$R_{DS} = \frac{1}{\mu_n C_{ox} \frac{W}{L} (V_{GS} - V_{TH})}$$

$$I_D = \mu_n C_{ox} \frac{W}{L} (V_{GS} - V_{TH}) V_{DS}$$



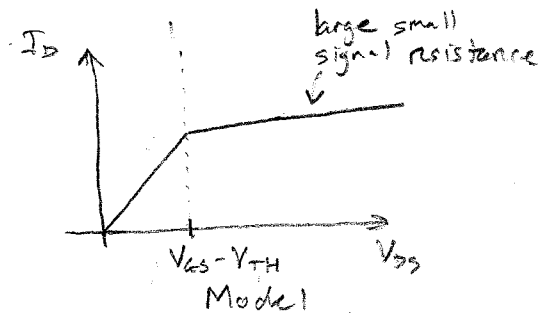
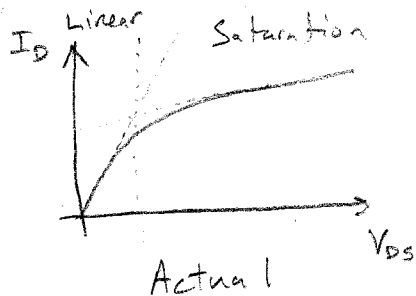
3. MOSFET as current source



Pinch off requirement:  $V_{GD} < V_{TH} \Rightarrow V_{DS} > V_{GS} - V_{TH}$

Saturation current:  $I_{DSAT} = \frac{1}{2} \mu_n C_{ox} \frac{W}{L} (V_{GS} - V_{TH})^2 (1 + 2V_{DS})$   
channel length modulation

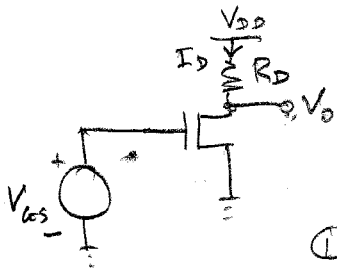
② & ③ form piecewise linear model of  $I_D$  vs.  $V_{DS}$



4. MOSFET as amplifier.

Key idea: control drain current with input voltage

- Today:
- look at two topologies, common source & common drain
  - design of an amplifier for a condenser microphone



Assume saturation, otherwise  $I_D$  is also a strong function of  $V_O$ .

$$\textcircled{1} V_O = V_{DD} - I_D R_D$$

$$\textcircled{2} I_D = \frac{1}{2} \mu_n C_{ox} \frac{W}{L} (V_{GS} - V_{TH})^2 \quad (\text{ignore } \lambda \text{ for now})$$

From here we can either

1. substitute  $\textcircled{2}$  into  $\textcircled{1}$  for the full large signal behavior.

\* 2. Assume  $V_{in}$  has just small changes on a nominal DC bias.

↳ Taylor series

$$I_D(V_{GS}) \quad @ \quad V_{GS} = V_{GS0} \quad @ \quad V_{GS0}$$

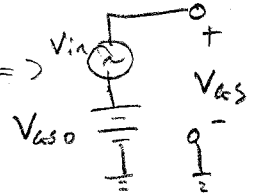
$$\frac{\partial I_D}{\partial V_{GS}} = \mu_n C_{ox} \frac{W}{L} (V_{in} - V_{TH}) \Rightarrow \mu_n C_{ox} \frac{W}{L} (V_{GS0} - V_{TH}) = g_m$$

$$\frac{\partial^2 I_D}{\partial V_{GS}^2} = \mu_n C_{ox} \frac{W}{L} \Rightarrow \mu_n C_{ox} \frac{W}{L} = B$$

$$\Rightarrow I_D(V_{GS}) = \underbrace{\frac{1}{2} \mu_n C_{ox} \frac{W}{L} (V_{GS0} - V_{TH})^2}_{\text{DC bias}} + \underbrace{g_m (V_{GS} - V_{GS0})}_{\text{linear gain}} + \underbrace{\frac{B}{2} (V_{GS} - V_{GS0})^2}_{\text{nonlinearity}}$$

(BJT will have higher order terms due to exp.)

$$\text{Let } V_{in} = V_{GS} - V_{GS0} \Rightarrow V_{GS} = V_{in} + V_{GS0}$$

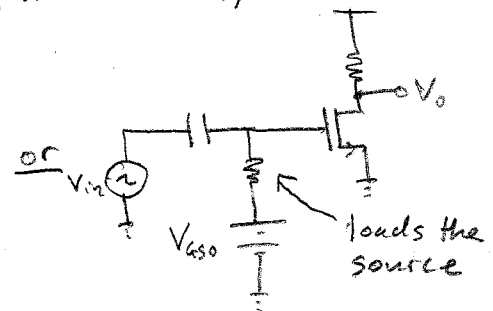
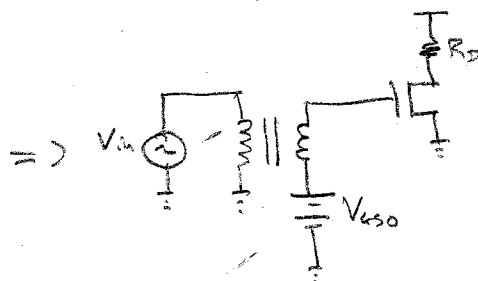
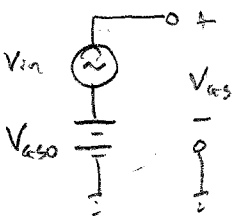


$$I_D = I_{D0} + g_m V_{in} + \frac{B}{2} V_{in}^2$$

ignore if  $|B V_{ov} V_{in}| \gg B V_{in}^2$

$$|V_{ov} V_{in}| \gg V_{in}^2$$

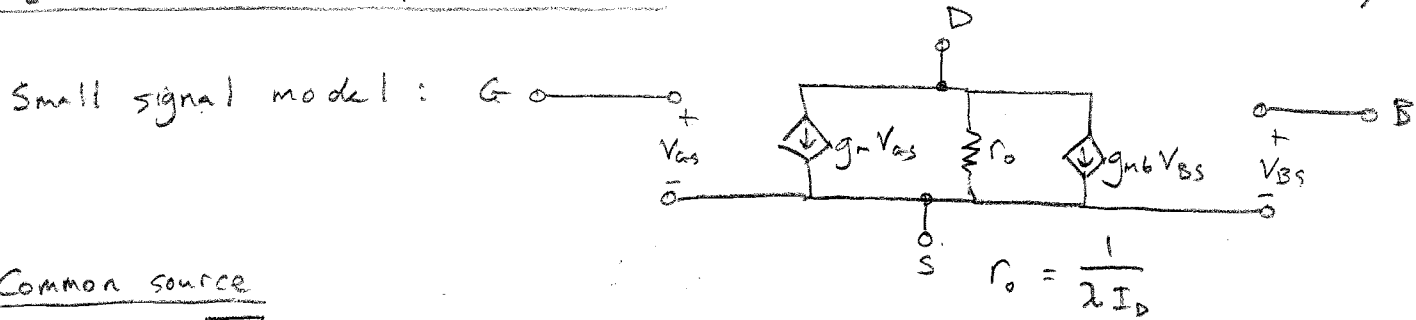
$$\boxed{V_{ov} \gg |V_{in}|} \quad (V_{ov} = V_{GS0} - V_{TH})$$



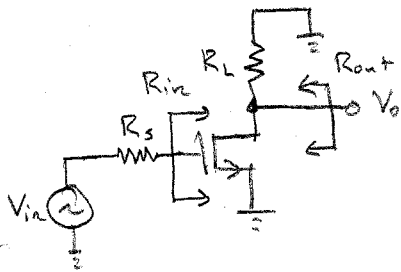
Notes:

- "small signal" and AC are not synonyms
- DC accurate amplifiers typically require differential pairs, a circuit that can take the difference of two inputs.

Single transistor amplifier stages (small signal, bias elements not shown)



Common source



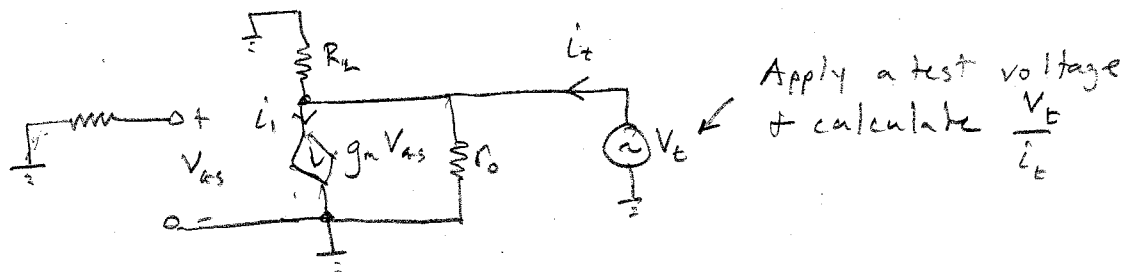
$$R_{in} = \infty \Rightarrow V_{gs} = V_{in}$$

$$\frac{V_o}{V_{in}} = -g_m R_{out}$$

$$R_{out} = R_L \parallel r_o$$

$R_{out}$  calc.

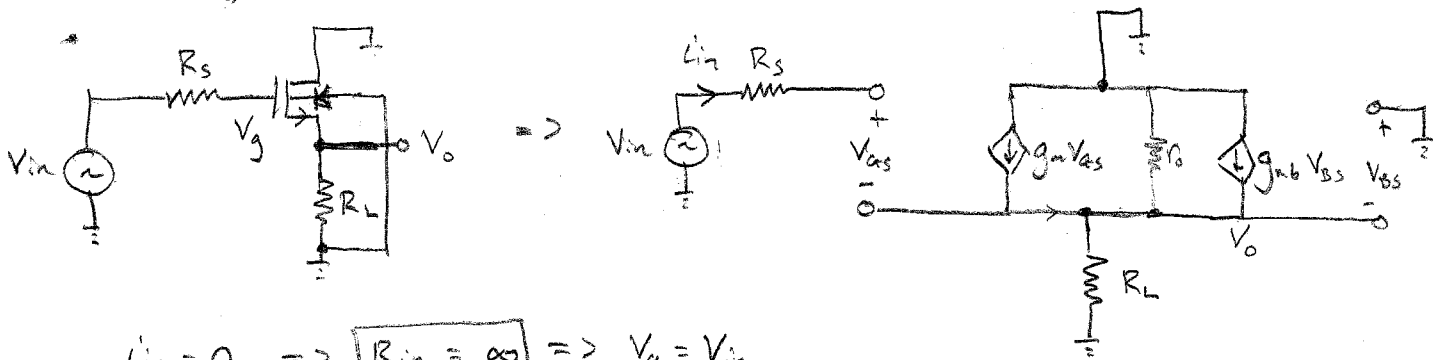
- Always set all independent sources to 0 first.



$$1. V_{gs} = 0 \Rightarrow I_t = 0$$

$$2. \frac{V_t}{I_t} = R_L \parallel r_o = R_{out}$$

# Common drain (Source follower)



$i_{in} = 0 \Rightarrow R_{in} = \infty \Rightarrow V_g = V_{in}$   
 KCL @  $V_o$

$$g_m V_{gs} - \frac{V_o}{r_o} + g_{mb} V_{bs} - \frac{V_o}{R_L} = 0$$

$$V_{gs} = V_{in} - V_o$$

$$V_{bs} = -V_o$$

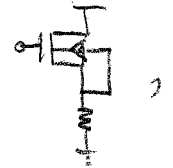
$$\Rightarrow g_m (V_{in} - V_o) - \frac{V_o}{r_o} + g_{mb} (-V_o) - \frac{V_o}{R_L} = 0$$

$$V_o \left( -g_m - \frac{1}{r_o} - g_{mb} - \frac{1}{R_L} \right) = V_{in} (-g_m)$$

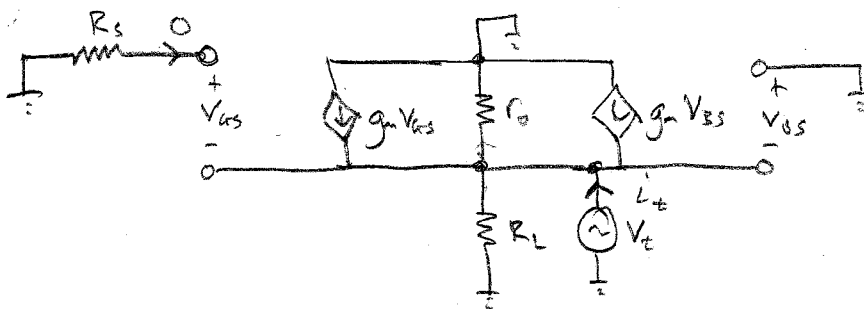
$$\boxed{\frac{V_o}{V_{in}} = \frac{g_m (r_o \parallel R_L)}{(g_m + g_{mb})(r_o \parallel R_L) + 1}}$$

For  $g_m \rightarrow \infty + g_{mb} \rightarrow 0 \Rightarrow \frac{V_o}{V_{in}} \rightarrow 1$

$g_{mb}$  degrades the gain! It would be nice if but this isn't possible in many cases due to processing restrictions. We would need many separate isolated substrates or wells.



## Ro.t



$$i_t + g_m V_{gs} + g_{mb} V_{bs} - V_t \left( \frac{1}{r_o} + \frac{1}{R_L} \right) = 0$$

$$V_{gs} = V_{bs} = -V_t$$

$$i_t = V_t \left( \frac{1}{r_o} + \frac{1}{R_L} + g_m + g_{mb} \right) \Rightarrow \boxed{\frac{V_t}{i_t} = r_o \parallel R_L \parallel \frac{1}{g_m} \parallel \frac{1}{g_{mb}} \approx \frac{1}{g_m}}$$

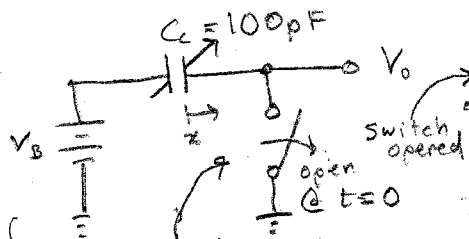
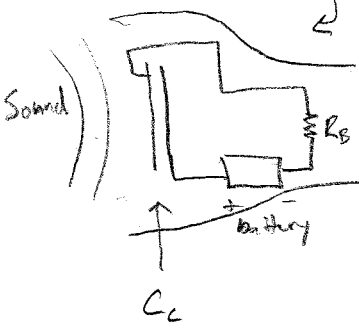
if  $g_m \gg g_{mb}, \frac{1}{r_o}, \frac{1}{R_L}$

What is the point of a source follower?

- gain is 1. Is this useful?
- $R_{out} \ll R_{in}$ .

Consider an audio amplifier for driving headphones from microphone input.

Condenser microphone: vibrations produce changes in capacitance gap.



in reality, this is just a very large resistor because we don't care about DC.

$$C_c = \frac{\epsilon A}{g_0 + x} \Rightarrow V_o = V_B - \frac{Q(x + g_0)}{\epsilon A}$$

Small signal gain  $\frac{\partial V_o}{\partial x} = -\frac{Q}{\epsilon A} = -\frac{V_B C_c}{\epsilon A} = -\frac{V_B}{g_0}$

- Capacitor is biased with a nominal voltage  $V_B$  creating a charge  $Q = V_B C_c$
- changes in gap cause changes in cap.
- Since charge is constant,  $V_o$  changes when cap changes.

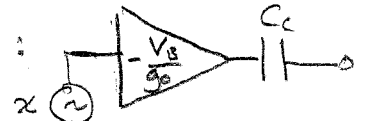
$$Q = C_c (V_B - V_o)$$

$$V_o = \frac{C_c V_B - Q}{C_c} = V_B - \frac{Q}{C_c}$$

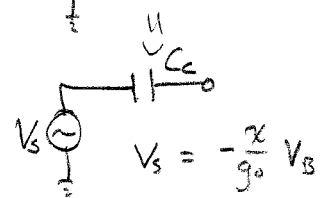
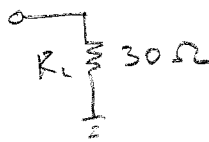
- Thevenin impedance is simply  $C_c$

$$V_o = -\frac{x}{g_0} V_B$$

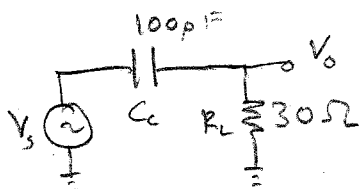
small signal model:



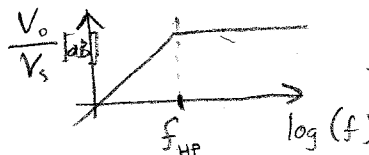
Headphones:



What happens if we connect the two?



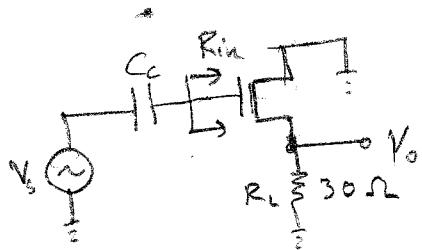
- Audio is ~20 Hz to 20 kHz
- $C_c + R_L$  form a high pass filter



$$f_{HP} = \frac{1}{2\pi R_L C_c} = 53 \text{ MHz!}$$

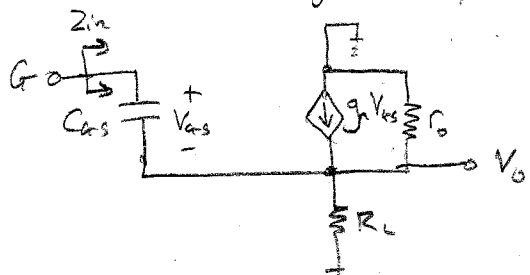
• Audio frequencies are greatly attenuated!

What if we use a follower?

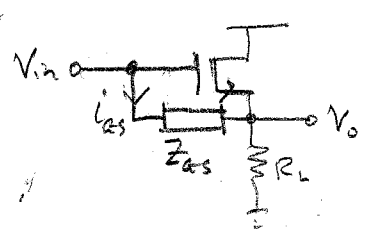


- $R_{in} = \infty$
- $V_o \approx V_s$  if  $|g_m R_L| \gg 1$
- If we have enough  $g_m$ , we can reduce the high pass filter effect by relying on large  $R_{in}$  + small  $R_{out}$

Note: real MOSFETs have gate capacitance.



- $C_{gs}$  means  $Z_{in}$  is finite. we'll study frequency response of amplifiers later.
- For source followers, there is another interesting advantage



if  $g_m R_L \gg 1$   $V_o \approx V_{in}$

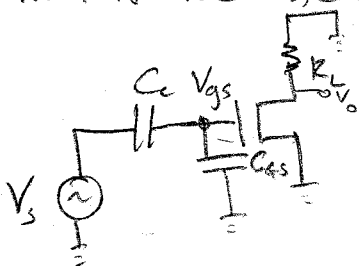
$$I_{gs} = \frac{V_{in} - V_o}{Z_{gs}}$$

As  $g_m R_L \rightarrow \infty$ ,  $I_{gs} \rightarrow 0$

1. with enough  $g_m R_L$ , input impedance can be arbitrarily large.

- ignores 2<sup>nd</sup> order effects such as  $g_{mb}$ , other parasitic caps, etc.

What if we used CS?



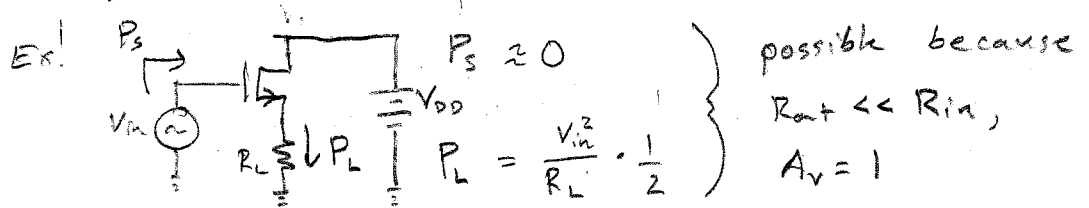
$$V_{gs} = \frac{C_c}{C_c + C_{gs}} V_s \Rightarrow \text{capacitance division at input.}$$

CS is typically used in front end circuit for gain, followed by CD for load driving.

$$\frac{V_o}{V_{in}} = -\frac{C_c}{C_c + C_{gs}} g_m R_L \Rightarrow \text{if } R_L \text{ is small, insert a second amplifier stage if more gain is necessary.}$$

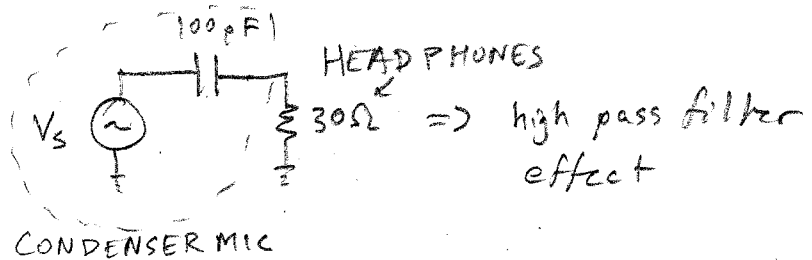
Observations from mic. amp design.

- 1. Amplifiers with voltage gain of 1 can still provide power gain.

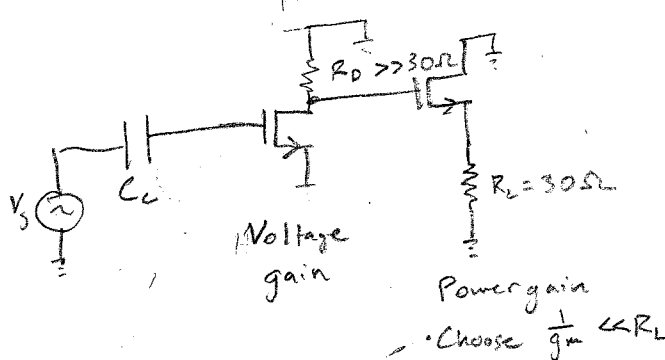


- Does not violate energy conservation. Power comes from battery. ( $P_{in} = P_{out} = P_L + P_{MOSFET}$ )
- Amplification = using a small signal to modulate the operating point of a higher power circuit.

- 2. Interfacing to sensors with very high impedance (large R, small C) is difficult due to loading effects.



- 3. Common drain stages offer extremely high input impedance, but cannot provide voltage gain.
- 4. Common source stages offer high input impedance + the potential for high gain if followed by a 2<sup>nd</sup> stage.



## gm equations

with  $V_{ds} = V_{dso}$

$g_m$  is defined as  $\frac{\partial I_D}{\partial V_{gs}}$ . From  $I_{Dsat} = \frac{1}{2} \mu_n C_{ox} \frac{W}{L} (V_{gs} - V_{TH})^2$ , we found  $\boxed{g_m = \mu_n C_{ox} \frac{W}{L} V_{ov}}$ , where

$V_{ov} = V_{dso} - V_{TH}$  is the overdrive voltage.

For BJTs,  $g_m = \frac{I_c}{V_T}$ . We can come up with a similar expression for FETs.

$$\frac{I_{Dsat}}{g_m} = \frac{1}{2} V_{ov} \Rightarrow \boxed{g_m = \frac{2I_{Dsat}}{V_{ov}}}$$

Also,  $2I_{Dsat} \mu_n C_{ox} \frac{W}{L} = (\mu_n C_{ox} \frac{W}{L} V_{ov})^2 = g_m^2$

$$\therefore \boxed{g_m = \sqrt{2I_{Dsat} \mu_n C_{ox} \frac{W}{L}}}$$

The second of these equations,  $g_m = \frac{2I_{Dsat}}{V_{ov}}$ , is generally the most useful:

- it's independent of sizing
- $V_{ov}$  is usually restricted by other considerations, such as linearity, noise, speed, and gain.
- It exposes the linear tradeoff between power ( $I_D$  assuming const  $V_{DD}$ ) &  $g_m$ .

• It allows interesting comparisons to BJTs

<u>BJT</u>	<u>MOSFET</u>
$g_m = \frac{I_c}{V_T}$	$g_m = \frac{2I_D}{V_{ov}}$

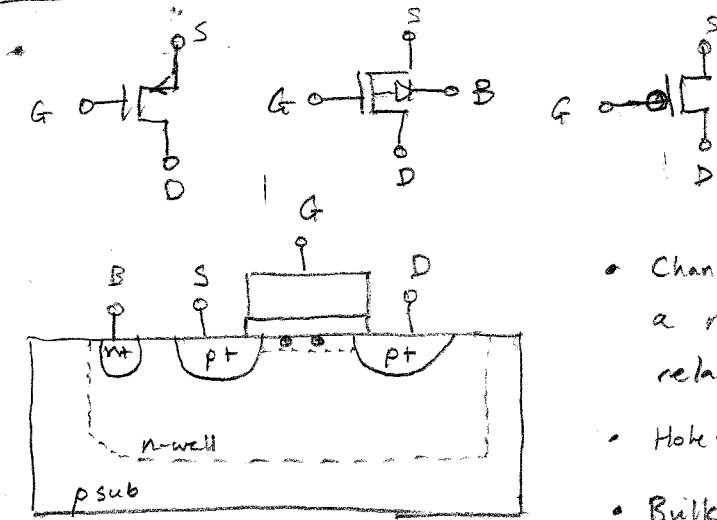
Can we just make  $V_{ov} < 2V_T$  in order to have a more power efficient device?

No  $\rightarrow$  the square law model breaks down for  $V_{ov} < \sim 100 \text{ mV}$ .

Known as weak inversion region:  $I_D = I_{se}^{V_{gs}/nV_T} \rightarrow n = 1.2 \dots 1.5$



# PMOS transistor



- Channel is formed by applying a negative voltage to the gate relative to S/B.
- Holes conduct current from S → D
- Bulk should be connected to  $V_{DD}$  - ensures parasitic diodes are off

$$I_{S \rightarrow D} = \frac{1}{2} \mu_p C_{ox} \frac{W}{L} (V_{SG} - V_{TP})^2$$

In Si

$$\begin{cases} \mu_p \leq 450 \frac{\text{cm}^2}{\text{V}\cdot\text{s}} \\ \mu_n \leq 1400 \frac{\text{cm}^2}{\text{V}\cdot\text{s}} \end{cases}$$

$\frac{\mu_n}{\mu_p} \approx 3 \Rightarrow$  are more current efficient in terms of  $g_m = \sqrt{2I_{DQ}\mu C_{ox} \frac{W}{L}}$  for identical sizing.

Note:  $V_{TN} \neq V_{TP}$  are usually different.

Remember:

S = highest potential p+ terminal in PMOS.

It is the "source" of holes.

S = lowest potential n+ terminal in NMOS.

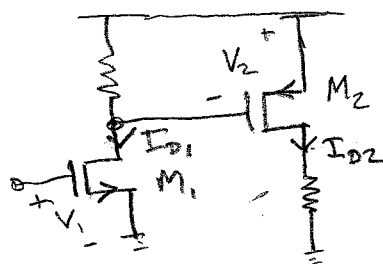
It is the "source" of electrons.

Current is defined as the flow of positive charge, so  $I_{S \rightarrow D, PMOS}$  is always positive,

$I_{S \rightarrow D, NMOS}$  is always negative.

\* It's much less confusing to simply label currents in a circuit with a direction that intuitively makes sense.

Ex.



$$I_{D1} = \frac{1}{2} \mu_n C_{ox} \frac{W}{L} (V_1 - V_{TN})^2$$

$$I_{D2} = \frac{1}{2} \mu_p C_{ox} \frac{W}{L} (V_2 - V_{TP})^2$$